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Assistant Commissioner for Patents Washington, D.C. 20231

PATENT
Attorney Docket No.: AM1126-D1/T8910
TTC Ref. No. 016301-008910

on July 24, 2000

By: Gynda Polisch



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Arlene
4/6/00
#7

In re application of:

KRAMADHATI V. RAVI et al.

Application No.: 09/362,504

Filed: July 27, 1999

For: METHOD FOR REDUCING THE
INTRINSIC STRESS OF HIGH
DENSITY PLASMA FILMS

Examiner: Rudy Zervigon

Art Unit: 1763

PETITION TO EXTEND TIME

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Assistant Commissioner for Patents
Washington, D.C. 20231

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APR 04 2000

TECHNOLOGY CENTER 2800

Sir:

Applicant petitions the Assistant Commissioner of Patents to extend the time for response to the Office Action dated November 22, 1999 for one (1) month, from February 22, 2000 to March 22, 2000. An appropriate response in the form of an Amendment is enclosed herewith.

Please charge the fee of \$110.00 to the undersigned's Deposit Account No. 20-1430. Please charge any additional fees or credit overpayment to the above deposit account. This petition is submitted in triplicate.

Respectfully submitted,

Chun-Pok Leung
Reg. No. 41,405

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